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Fairchild Semiconductor FQPF7N60

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Datasheet of FQPF7N60 - MOSFET N-CH 600V 4.3A TO-220F Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



November 2013

FQPF7N60

N-Channel QFET $^{ m R}$ MOSFET 600 V, 4.3 A, 1 Ω

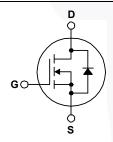
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 4.3 A, 600 V, $R_{DS}(on)$ = 1.0 Ω (Max.) @ V_{GS} = 10 V, I_{D} = 2.2 A
- Low Gate Charge (Typ. 29 nC)
- Low C_{rss} (Typ. 16 pF)
- · 100% Avalanche Tested





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQPF7N60	Unit	
V _{DSS}	Drain-Source Voltage		600	V	
I _D	Drain Current - Continuous (T _C = 25°C	C)	4.3	Α	
	- Continuous (T _C = 100°C)		2.7	Α	
I _{DM}	Drain Current - Pulsed	(Note 1)	17.2	Α	
V _{GSS}	Gate-Source Voltage		± 30	V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	580	mJ	
I _{AR}	Avalanche Current	(Note 1)	4.3	Α	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	4.8	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns	
P_{D}	Power Dissipation (T _C = 25°C)		48	W	
	- Derate above 25°C		0.38	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
T _L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C	

Thermal Characteristics

Symbol	Parameter	FQPF7N60	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	2.60	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W	



Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQPF7N60	FQPF7N60	TO-220F	Tube	N/A	N/A	50 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA				V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.67		V/°C
I _{DSS}	Zero Code Vellana Brain Consul	V _{DS} = 600 V, V _{GS} = 0 V			10	μΑ
	Zero Gate Voltage Drain Current	V _{DS} = 480 V, T _C = 125°C			100	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
On Cha	aracteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 2.2 A		0.8	1.0	Ω
g _{FS}	Forward Transconductance	V _{DS} = 50 V, I _D = 2.2 A		6.4		S
C _{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$		1100	1430	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		135	175	pF
C _{rss}	Reverse Transfer Capacitance			16	21	pF
Switch	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 300 V, I _D = 7.4 A,		30	70	ns
t _r	Turn-On Rise Time	$V_{DD} = 300 \text{ V}, I_D = 7.4 \text{ A},$ $R_G = 25 \Omega$		80	170	ns
t _{d(off)}	Turn-Off Delay Time	116 - 20 32		65	140	ns
t _f	Turn-Off Fall Time	(Note 4)	/	60	130	ns
Qg	Total Gate Charge	V _{DS} = 480 V, I _D = 7.4 A,		29	38	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V	/	7		nC
Q _{gd}	Gate-Drain Charge	(Note 4)		14.5		nC
Drain-S	Source Diode Characteristics a	nd Maximum Ratings				
I _S					4.3	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				17.2	Α
	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 4.3 A			1.4	V
V_{SD}						
V _{SD}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 7.4 A,		320		ns

- Notes: Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature. 2. L = 57.6 mH, I $_{AS}$ = 4.3 A, V $_{DD}$ = 50 V, R $_{G}$ = 25 Ω , starting T $_{J}$ = 25°C. 3. I $_{SD}$ \leq 7.4 A, di/dt \leq 200 A/ $_{HS}$, V $_{DD}$ \leq B V $_{DSS}$, starting T $_{J}$ = 25°C. 4. Essentially independent of operating temperature.



Typical Characteristics

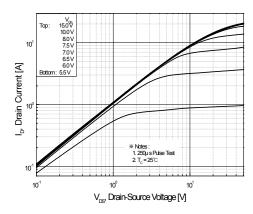


Figure 1. On-Region Characteristics

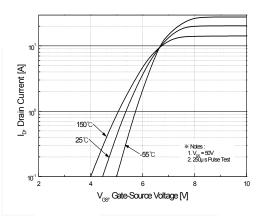


Figure 2. Transfer Characteristics

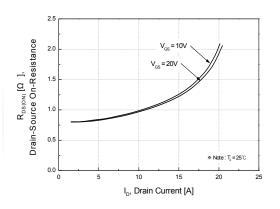


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

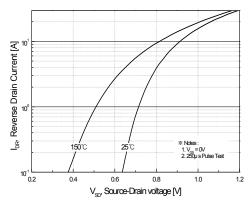


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

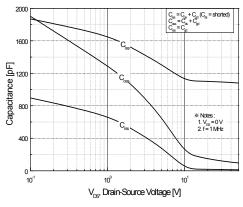


Figure 5. Capacitance Characteristics

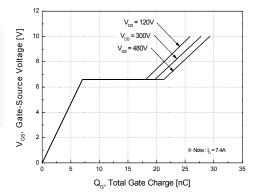
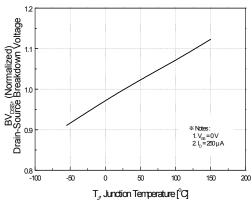


Figure 6. Gate Charge Characteristics



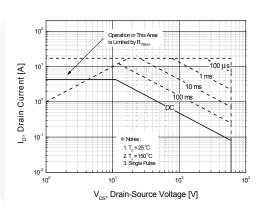
Typical Characteristics



30 25 (paging 20) 15 (paging 20) 15

Figure 7. Breakdown Voltage Variation vs. Temperature

Figure 8. On-Resistance Variation vs. Temperature



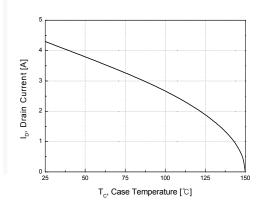


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

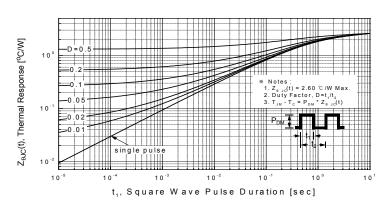


Figure 11. Transient Thermal Response Curve



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Figure 12. Gate Charge Test Circuit & Waveform

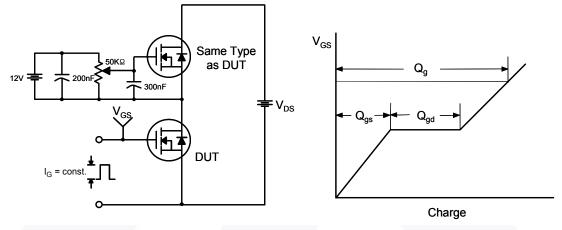


Figure 13. Resistive Switching Test Circuit & Waveforms

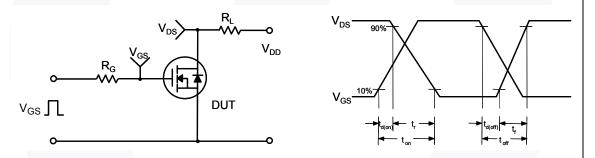
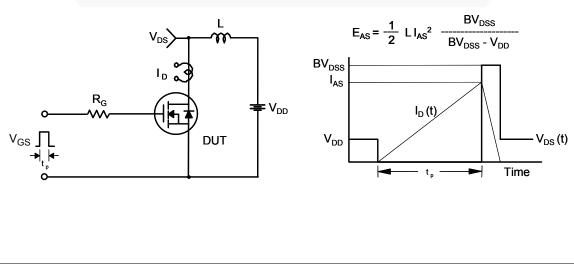


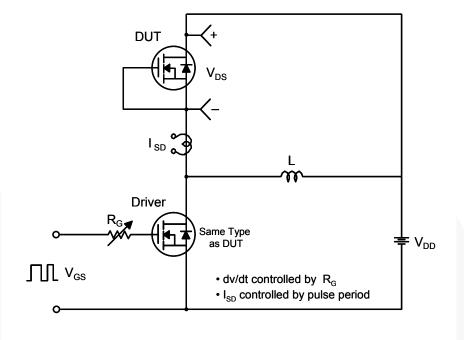
Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

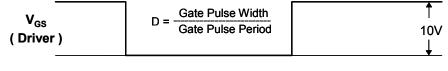


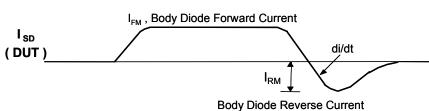
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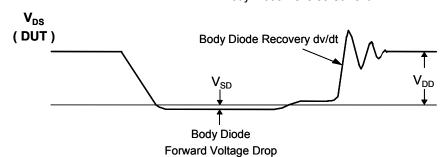


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms









Mechanical Dimensions

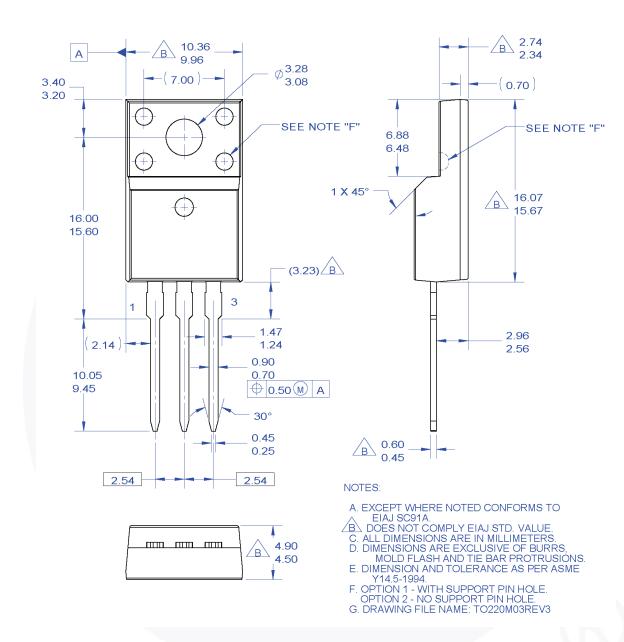


Figure 16. TO220, Molded, 3-Lead, Full Pack, EIAJ SC91, Straight Lead

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